## 1.0 ELECTRICAL CHARACTERISTICS

#### Absolute Maximum Ratings†

Supply Voltage (V <sub>DD</sub> to GND)6.0V
RESET, RESET
Input Current, V <sub>DD</sub> 20 mA
Output Current, RESET, RESET
dV/dt (V <sub>DD</sub> )100V/µsec
Operating Temperature Range40°C to +125°C
Power Dissipation ( $T_A = 70^{\circ}C$ ):
3-Pin SOT-23B (derate 4 mW/°C above +70°C)
3-Pin SC-70 (derate 2.17 mW/°C above +70°C)174 mW
Storage Temperature Range65°C to +150°C
Maximum Junction Temperature, $T_{\rm J}  150^{\circ} \mbox{C}$

**†** Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS**

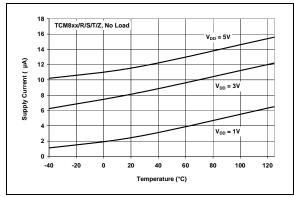
Parameter	Sym	Min	Тур	Max	Units	Test Conditions
V <sub>DD</sub> Range		1.0	_	5.5	V	$T_A = 0^{\circ}C$ to +70°C
		1.2		5.5		$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$
Supply Current	I <sub>CC</sub>	_	12	30	μA	<b>TCM8xx</b> L/M/J: V <sub>DD</sub> < 5.5V
		_	9	25		<b>TCM8xx</b> R/S/T/Z: V <sub>DD</sub> < 3.6V
Reset Threshold (Note 2)	V <sub>TH</sub>	4.56	4.63	4.70	V	<b>TCM8xx</b> L: T <sub>A</sub> = +25°C
		4.50	_	4.75		$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$
		4.31	4.38	4.45	V	<b>TCM8xx</b> M: T <sub>A</sub> = +25°C
		4.25	—	4.50	V	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$
		3.93	4.00	4.06	V	<b>TCM809</b> J: T <sub>A</sub> = +25°C
		3.89	_	4.10	V	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$
		3.04	3.08	3.11	V	<b>TCM8xx</b> T: T <sub>A</sub> = +25°C
		3.00	_	3.15	V	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
		2.89	2.93	2.96	V	<b>TCM8xx</b> S: $T_A = +25^{\circ}C$
		2.85	—	3.00	V	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$
		2.59	2.63	2.66	V	<b>TCM8xx</b> R: $T_A = +25^{\circ}C$
		2.55	_	2.70	V	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$
		2.28	2.32	2.35	V	<b>TCM8xx</b> Z: T <sub>A</sub> = +25°C
		2.25	—	2.38	V	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$
Reset Threshold Tempco		—	30	—	ppm/°C	
V <sub>DD</sub> to Reset Delay,		—	65	_	µsec	$V_{DD} = V_{TH}$ to ( $V_{TH} - 100$ mV) (Note 2)
Reset Active Time Out Period		140	320	560	msec	
RESET Output Voltage	V <sub>OL</sub>	—	—	0.3	V	<b>TCM809</b> R/S/T/Z: $V_{DD} = V_{TH} \text{ min}, I_{SINK} = 1.2 \text{ mA}$
Low ( <b>TCM809</b> )		—	—	0.4		TCM809L/M/J: $V_{DD} = V_{TH} \text{ min}, I_{SINK} = 3.2 \text{ mA}$
		_	_	0.3		V <sub>DD</sub> > 1.0V, I <sub>SINK</sub> = 50 μA
RESET Output Voltage	V <sub>OH</sub>	0.8 V <sub>DD</sub>	_	—	V	TCM809R/S/T/Z: $V_{DD} > V_{TH}$ max, $I_{SOURCE}$ = 500 $\mu$
High ( <b>TCM809</b> )		V <sub>DD</sub> – 1.5	—	_		TCM809L/M/J: $V_{DD} > V_{TH} \text{ max}$ , $I_{SOURCE} = 800 \ \mu\text{A}$
RESET Output Voltage	V <sub>OL</sub>	_	_	0.3	V	TCM810R/S/T/Z:V <sub>DD</sub> = V <sub>TH</sub> max, I <sub>SINK</sub> = 1.2 mA
Low ( <b>TCM810</b> )		—	_	0.4		<b>TCM810</b> L/M: $V_{DD} = V_{TH} \max$ , $I_{SINK} = 3.2 \text{ mA}$
RESET Output Voltage High ( <b>TCM810</b> )	V <sub>OH</sub>	0.8 V <sub>DD</sub>	_	_	V	$1.8 < V_{DD} < V_{TH} min, I_{SOURCE} = 150 \mu A$

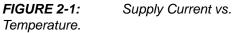
Note 1: <u>Production</u> testing done at  $T_A = +25^{\circ}C$ , overtemperature limits ensured by QC screen.

2: RESET output for **TCM809**, RESET output for **TCM810**.

## 2.0 TYPICAL PERFORMANCE CHARACTERISTICS

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.





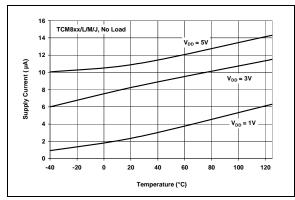


FIGURE 2-2: Supply Current vs. Temperature.

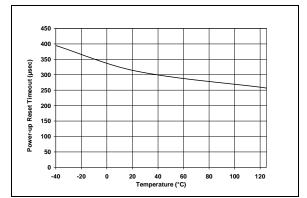


FIGURE 2-3: Power-up Reset Time Out vs. Temperature.

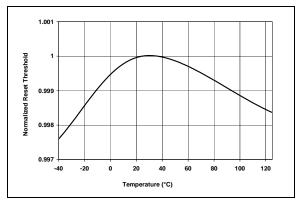


FIGURE 2-4: Normalized Reset Threshold vs. Temperature.

## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are given in Table 3-1.

#### TABLE 3-1: PIN FUNCTION TABLE

NAME	FUNCTION				
GND	Ground				
RESET (TCM809)	RESET push-pull output				
RESET (TCM810)	RESET push-pull output				
V <sub>DD</sub>	Supply voltage (+2.5V, +3.0V, +3.3V, +5.0V).				

#### 3.1 Ground (GND)

Ground terminal.

## 3.2 RESET Output (TCM809)

The  $\overline{\text{RESET}}$  push-pull output remains low while  $V_{DD}$  is below the reset voltage threshold, and for 240 msec (140 msec min.) after  $V_{DD}$  rises above reset threshold.

### 3.3 RESET Output (TCM810)

The RESET push-pull output remains high while  $V_{DD}$  is below the reset voltage threshold, and for 240 msec (140 msec min.) after  $V_{DD}$  rises above reset threshold.

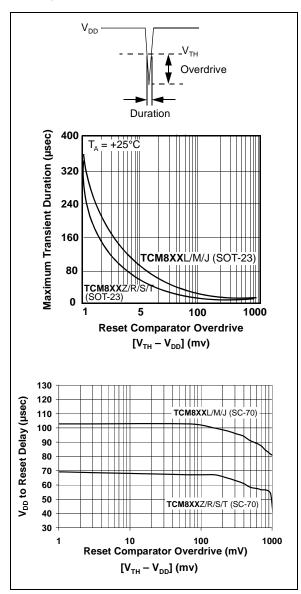
#### 3.4 Supply Voltage (V<sub>DD</sub>)

 $V_{DD}\!\!:+\!2.5V\!,+\!3.0V\!,+\!3.3V$  and  $+\!5.0V\!$ 

## 4.0 APPLICATIONS INFORMATION

### 4.1 V<sub>DD</sub> Transient Rejection

The TCM809/TCM810 provides accurate  $V_{DD}$  monitoring and reset timing during power-up, power-down and brown-out/sag conditions. These devices also reject negative-going transients (glitches) on the power supply line. Figure 4-1 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive that lies under the curve will not generate a reset signal.

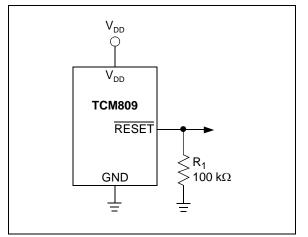


**FIGURE 4-1:** Maximum Transient Duration vs. Overdrive for Glitch Rejection at +25°C.

Combinations above the curve are detected as a brown-out or power-down condition. Transient immunity can be improved by adding a capacitor in close proximity to the  $V_{DD}$  pin of the TCM809/TCM810.

#### 4.2 RESET Signal Integrity During Power-Down

The TCM809 RESET output is valid to  $V_{DD} = 1.0V$ . Below this voltage the output becomes an "open circuit" and does not sink current. This means CMOS logic inputs to the microcontroller will be floating at an undetermined voltage. Most digital systems are completely shut down well above this voltage. However, in situations where RESET must be maintained valid to  $V_{DD} = 0V$ , a pull-down resistor must be connected from RESET to ground to discharge stray capacitances and hold the output low (Figure 4-2). This resistor value, though not critical, should be chosen such that it does not appreciably load RESET under normal operation (100 k $\Omega$  will be suitable for most applications). Similarly, a pull-up resistor to  $V_{\text{DD}}$  is required for the TCM810 to ensure a valid high RESET for V<sub>DD</sub> below 1.0V.



**FIGURE 4-2:** The addition of  $R_1$  at the <u>RESET</u> output of the TCM809 ensures that the RESET output is valid to  $V_{DD} = 0V$ .

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#### 4.3 Controllers and Processors With Bidirectional I/O Pins

Some microcontrollers have bidirectional reset pins. Depending on the current drive capability of the controller pin, an indeterminate logic level may result if there is a logic conflict. This can be avoided by adding a 4.7 k $\Omega$  resistor in series with the output of the TCM809/TCM810 (Figure 4-3). If there are other components in the system that require a reset signal, they should be buffered so as not to load the reset line. If the other components are required to follow the reset I/O of the microcontroller, the buffer should be connected as shown with the solid line.

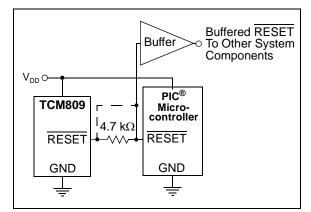
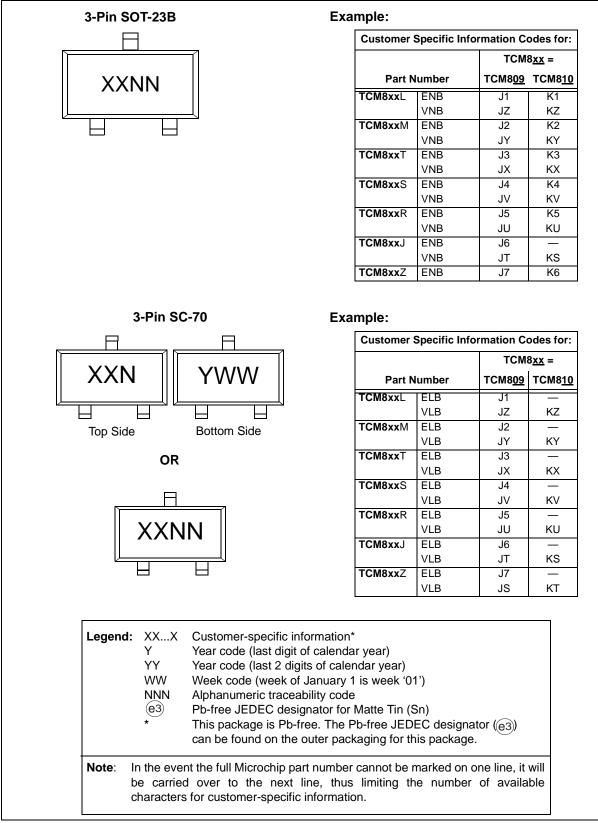


FIGURE 4-3: Interfacing the TCM809 to a Bidirectional RESET I/O.

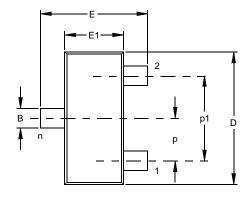
## 5.0 PACKAGING INFORMATION

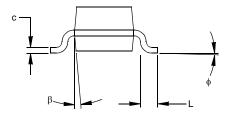
### 5.1 Package Marking Information

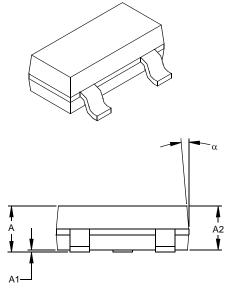


#### 3-Lead Plastic Small Outline Transistor (NB) (SOT-23)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging







Unit	INCHES*	MILLIMETERS		
Dimension Limits	NOM MAX MIN	NOM MAX		
of Pins n	3	3		
р	.038	0.96		
ead pitch (basic) p1	.076	1.92		
eight A	.040 .044 0.8	39 1.01 1.12		
ackage Thickness A2	035 .037 .040 0.8	38 0.95 1.02		
§ A1	.000 .002 .004 0.	0.06 0.10		
/idth E	.093 .093 .104 2.	10 2.37 2.64		
ackage Width E1	.051 .055 1.2	20 1.30 1.40		
ength D	110 .115 .120 2.8	30 2.92 3.04		
gth L	.014 .018 .022 0.3	35 0.45 0.55		
le ø	0 5 10	0 5 10		
ckness c	.004 .006 .007 0.0	0.14 0.18		
th B	.015 .017 .020 0.3	0.44 0.51		
ft Angle Top α	0 5 10	0 5 10		
ft Angle Bottom β	0 5 10	0 5 10		
ckness c tth B ft Angle Top α	004 .006 .007 0.1   015 .017 .020 0.3   0 5 10	09 0.14 37 0.44 0 5		

\* Controlling Parameter

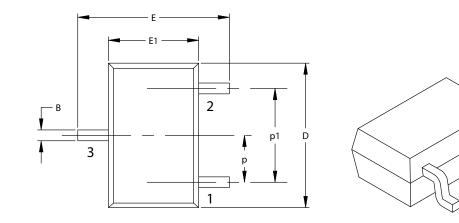
§ Significant Characteristic

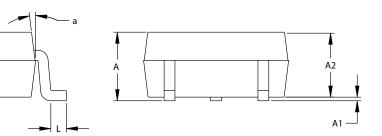
#### Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: TO-236 Drawing No. C04-104

#### 3-Lead Plastic Small Outline Transistor (LB) (SC-70)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging





	Units			MILLIMETERS*		
Dimension Li	mits	MIN	MAX	MIN	MAX	
Number of Pins		3	3	3		
Pitch	р	.026 BS	.026 BSC.		0.65 BSC.	
Outside lead pitch (basic)	p1	.051 BSC.		1.30 BS	1.30 BSC.	
Overall Height	Α	.031	.043	0.80	1.10	
Molded Package Thickness	A2	.031	.039	0.80	1.00	
Standoff	A1	.000	.0004	0.00	.010	
Overall Width	E	.071	.094	1.80	2.40	
Molded Package Width	E1	.045	.053	1.15	1.35	
Overall Length	D	.071	.089	1.80	2.25	
Foot Length	L	.004	.016	0.10	0.41	
Lead Thickness	с	.003	.010	0.08	0.25	
Lead Width	В	.006	.016	0.15	0.40	
Mold Draft Angle Top	а	8°	12°	8°	12°	
Mold Draft Angle Bottom	b	8°	12°	8°	12°	

\*Controlling Parameter

Notes:

С

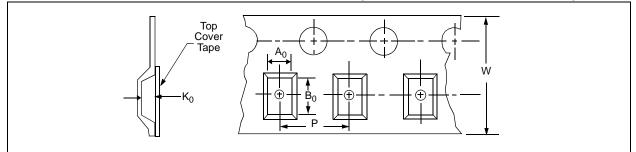
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .005" (0.127mm) per side.

JEITA (EIAJ) Equivalent: SC70 Drawing No. C04-104

# TCM809/TCM810

#### 5.2 Product Tape and Reel Specifications

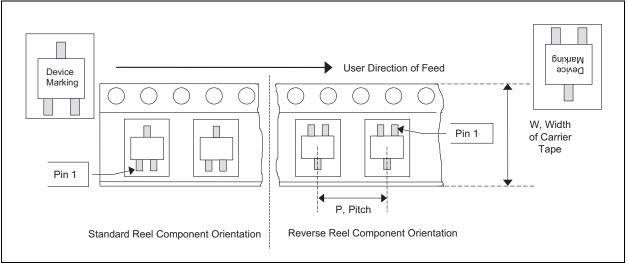
#### FIGURE 5-1: EMBOSSED CARRIER DIMENSIONS (8, 12, 16 AND 24 MM TAPE ONLY)



#### TABLE 1: CARRIER TAPE/CAVITY DIMENSIONS

Case	Package		Carrier Dimensions		Cavity Dimensions			Output	Reel Diameter in
Outline Type			W mm	P mm	A0 mm	B0 mm	K0 mm	Quantity Units	mm
NB	SOT-23	3L	8	4	3.15	2.77	1.22	3000	180
LB	SC-70	3L	8	4	2.4	2.4	1.19	3000	180

#### FIGURE 5-2: 3-LEAD SOT-23/SC70 DEVICE TAPE AND REEL SPECIFICATIONS



## APPENDIX A: REVISION HISTORY

#### **Revision E (December 2012)**

• Added a note to each package outline drawing.

#### **Revision D (March 2005)**

- Updated 6.0 "Packaging Information" to include old and new packaging examples.
- Applied new template and rearranged sections to be consistent with current documentation.

### **Revision C (April 2004)**

#### **Revision B (January 2002)**

## Revision A (May 2001)

Initial release of data sheet.

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# TCM809/TCM810

NOTES:

## **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	<u>×</u>	<u>×</u>	<u>XXXXX</u>	Exa	amples:	
	V <sub>DD</sub> Reset reshold	Temperature Range	Package	a)	TCM809LENB713:	SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +85°C, Tape and Reel.
Device:	TCM810:	Supervisor circuit w	rith active-low RESET ou rith active-high RESET o		TCM809LVLB713:	SC-70-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
V <sub>DD</sub> Reset Threshold:	$ \begin{array}{rcl} M & = & 4.3 \\ J & = & 4.0 \\ T & = & 3.0 \\ S & = & 2.9 \\ R & = & 2.0 \end{array} $	38V 00V 08V 93V 63V		c)	TCM809LVNB713:	SOT-23B-3-TR, Microcontroller 4.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
Temperature Range:	E = -4	32∨ 0°C to +85°C 0°C to +125°C		a)	TCM810MENB713:	SOT-23B-3-TR, Microcontroller 4.38V Reset Monitor, -40°C to +85°C, Tape and Reel.
Package:		SOT-23B, 3-pin (Ta SC-70, 3-pin (Tape		b)	TCM810RVLB713:	SOT-23B-3-TR, Microcontroller 2.63V Reset Monitor, -40°C to +125°C, Tape and Reel.
				c)	TCM810TVLB713:	SC-70-3-TR, Microcontroller 4.38V Reset Monitor, -40°C to +125°C, Tape and Reel.

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# TCM809/TCM810

NOTES:

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